

USBLC6-2SC6Y

Datasheet - production data

Automotive very low capacitance ESD protection

Features

- 2 data lines protected
- Protects V_{BUS}
- Very low capacitance: 2.5 pF
- Very low leakage current: 10 nA
- SOT23-6L package
- RoHS compliant
- AEC-Q101 qualified

Benefits

- Very low capacitance between lines to GND for optimized data integrity and speed
- Low PCB space consumption
- Enhanced ESD protection. ISO10605 up to 25 kV guaranteed at device level
- ESD protection of V_{BUS}
- High reliability offered by monolithic integration
- Fast response time
- Consistent D+ / D- signal balance:
 - Very low capacitance matching tolerance I/O to GND = 0.015 pF
 - Compliant with USB 2.0 requirements

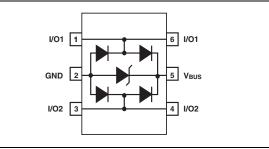
Complies with the following standards

- ISO10605: C = 150 pF, R = 330 Ω
 - 25 kV (air discharge)
 - 15 kV (contact discharge)
- ISO10605: C = 330 pF, R = 330 Ω
 - 15 kV (air discharge)
 - 15 kV (contact discharge)
- ISO7637-3
 - Pulse 3a: Vs = -150 V
 - Pulse 3b: Vs = +100 V



SOT23-6L USBLC6-2SC6Y(JEDEC MO178AB)

Figure 1. Functional diagram



Applications

- USB 2.0 ports up to 480 Mb/s (high speed)
- Compatible with USB 1.1 low and full speed
- High-speed datalines in smart junction boxes
- Ethernet port: 10/100 Mb/s
- Video line protection

Description

The USBLC6-2SC6Y is a monolithic device dedicated to ESD protection of high speed interfaces, such as USB 2.0, Ethernet links and video lines.

The very low line capacitance secures a high level of signal integrity without compromising in protecting sensitive chips against the most stringent characterized ESD strikes.

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September 2012

Doc ID 023201 Rev 2

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This is information on a product in full production.

1 Characteristics

Symbol		Value	Unit	
V _{PP} ⁽¹⁾	Peak pulse voltage	ISO 10605 (C = 150 pF, R = 330Ω): Air discharge Contact discharge ISO 10605 (C = $300 pF$, R = 330Ω): Air discharge Contact discharge	25 15 15 15	kV
T _{stg}	Storage temperature range		-55 to +150	°C
Тj	Operating junction temperature range		-40 to +150	°C
ΤL	Lead solder temperature (260	°C	

Table 1. Absolute ratings

1. For a surge greater than the maximum values, the diode will fail in short-circuit.

Figure 2. Electrical characteristics (definitions)

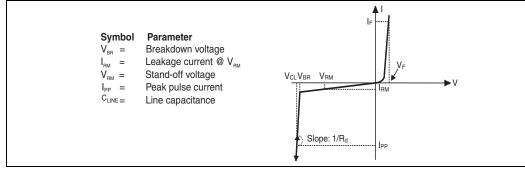


Table 2.	Electrical	characteristics	(T _{amb} =	= 25 °	°C)
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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{RM}	Leakage current	V _{RM} = 5.25 V		10	150	nA
V _{BR}	Breakdown voltage between V _{BUS} and GND	I _R = 1 mA	6			V
V _F	Forward voltage	I _F = 10 mA			1.1	V
N.	Clamping voltage	I _{PP} = 1 A, 8/20 μs Any I/O pin to GND			12	v
V _{CL}		I _{PP} = 5 A, 8/20 μs Any I/O pin to GND			17	v
C _{i/o-GND}	Capacitance between I/O and GND			2.5	3.5	
$\Delta C_{i/o-GND}$	Interline capacitance matching between I/O and GNDVR = 1.65 V0.015			pF		
C _{i/o-i/o}	Capacitance between I/O			1.2	1.7	
ΔC _{i/o-i/o}	Interline capacitance matching between I/O	V _R = 1.65 V		0.04		pF



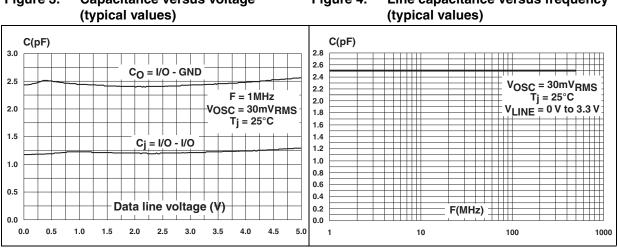


Figure 6.

Figure 3. Capacitance versus voltage



Relative variation of leakage Figure 5. current versus junction temperature (typical values)

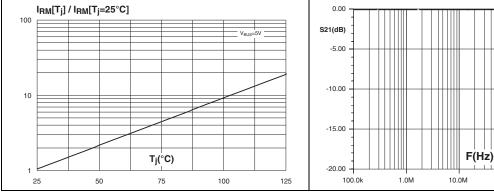
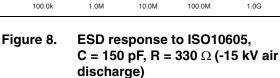
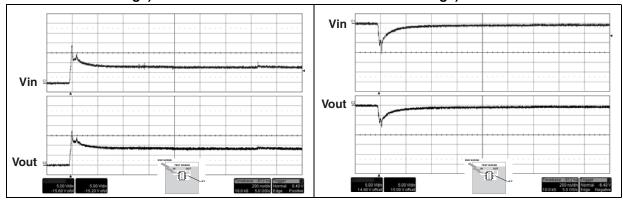


Figure 7. ESD response to ISO10605, C= 150 pF, R = 330 Ω (+15 kV air discharge)



Frequency response



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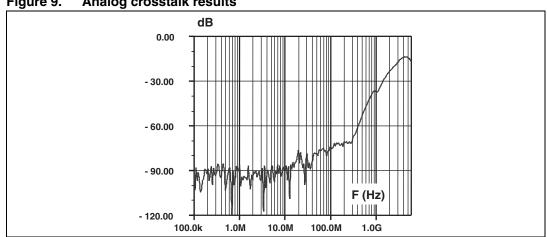


Figure 9. Analog crosstalk results

Application and design guidelines 2

More information is available in the STMicroelectronics Application note AN2689, "Protection of automotive electronics from electrical hazards, guidelines for design and component selection".

Ordering information scheme 3

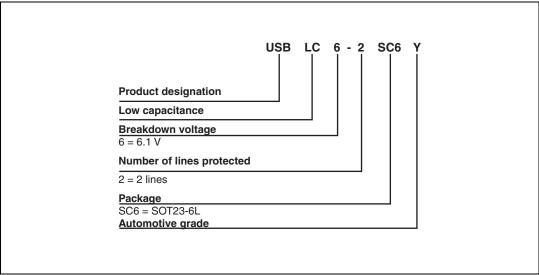


Figure 10. Ordering information scheme



4 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 3. SOT23-6L dimensions

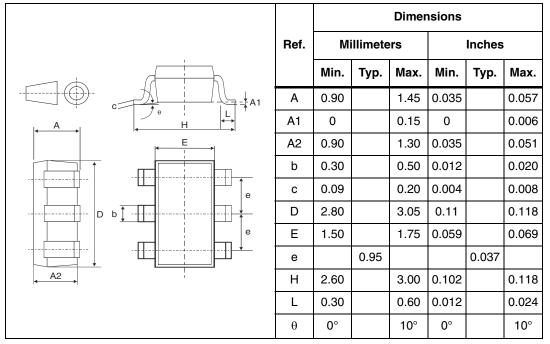
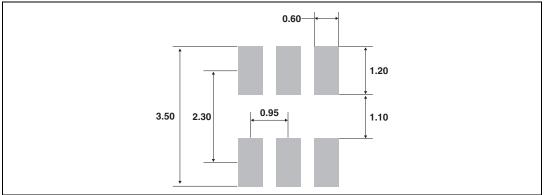


Figure 11. SOT23-6L footprint



5 Recommendation on PCB assembly

5.1 Solder paste

- 1. Use halide-free flux, qualification ROL0 according to ANSI/J-STD-004.
- 2. "No clean" solder paste recommended.
- 3. Offers a high tack force to resist component displacement during PCB movement.
- 4. Use solder paste with fine particles: powder particle size 20-45 μ m.

5.2 Placement

- 1. Manual positioning is not recommended.
- 2. It is recommended to use the lead recognition capabilities of the placement system, not the outline centering.
- 3. Standard tolerance of \pm 0.05 mm is recommended.
- 4. 3.5 N placement force is recommended. Too much placement force can lead to squeezed out solder paste and cause solder joints to short. Too low placement force can lead to insufficient contact between package and solder paste that could cause open solder joints or badly centered packages.
- 5. To improve the package placement accuracy, a bottom side optical control should be performed with a high resolution tool.
- 6. For assembly, a perfect supporting of the PCB (all the more on flexible PCB) is recommended during solder paste printing, pick and place and reflow soldering by using optimized tools.

5.3 PCB design preference

- 1. To control the solder paste amount, the closed via is recommended instead of open vias.
- 2. The position of tracks and open vias in the solder area should be well balanced. The symmetrical layout is recommended, in case any tilt phenomena caused by asymmetrical solder paste amount due to the solder flow away.



5.4 Reflow profile

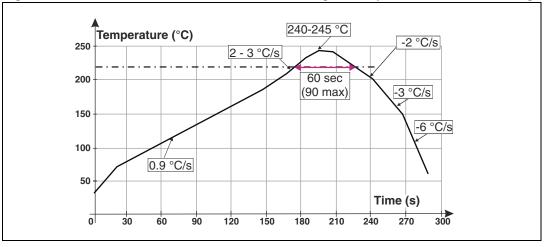


Figure 12. ST ECOPACK[®] recommended soldering reflow profile for PCB mounting

Note: Minimize air convection currents in the reflow oven to avoid component movement.



6 Ordering information

Table 4.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
USBLC6-2SC6Y	UL2Y	SOT23-6L	16.7 mg	3000	Tape and reel

7 Revision history

Table 5.Document revision history

Date	Revision	Changes
16-May-2012	1	First issue.
06-Sep-2012	2	Updated dimensions A max., b min. and L min. in Table 3.

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